

## UTT30N10

Power MOSFET

## 30A, 100V N-CHANNEL POWER MOSFET

### ■ DESCRIPTION

The UTC UTT30N10 is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance, low gate charge and high switching speed.

The UTC UTT30N10 is suitable for high voltage synchronous rectifier and DC/DC converters, etc.

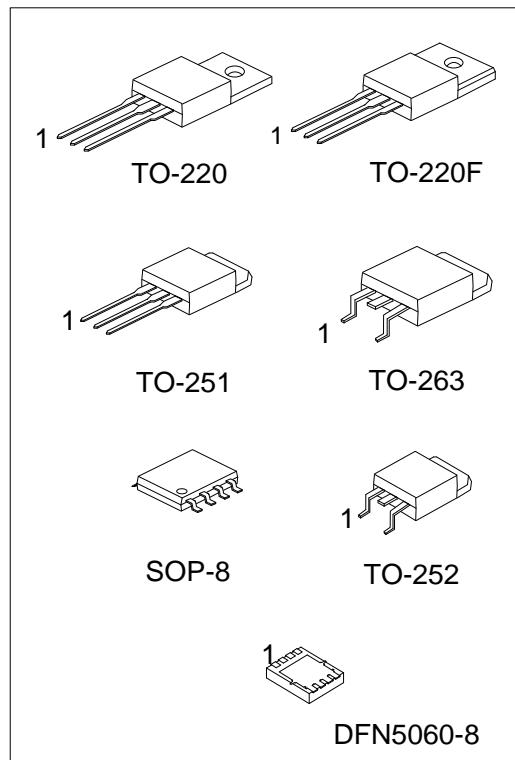
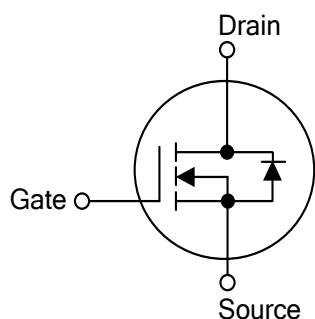
### ■ FEATURES

- \*  $R_{DS(ON)} \leq 52 \text{ m}\Omega$  @  $V_{GS}=10\text{V}$ ,  $I_D=30\text{A}$

- $R_{DS(ON)} \leq 72 \text{ m}\Omega$  @  $V_{GS}=4.5\text{V}$ ,  $I_D=15\text{A}$

- \* High Switching Speed

### ■ SYMBOL



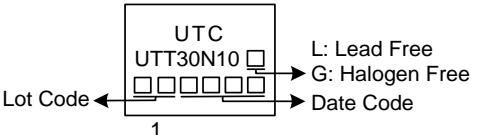
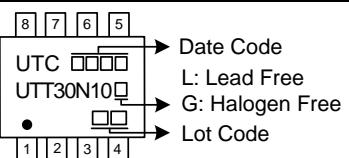
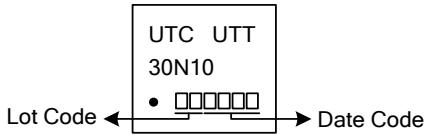
### ■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UTT30N10L-TA3-T	UTT30N10G-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
UTT30N10L-TF3-T	UTT30N10G-TF3-T	TO-220F	G	D	S	-	-	-	-	-	Tube
UTT30N10L-TM3-T	UTT30N10G-TM3-T	TO-251	G	D	S	-	-	-	-	-	Tube
UTT30N10L-TN3-R	UTT30N10G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
UTT30N10L-TQ2-T	UTT30N10G-TQ2-T	TO-263	G	D	S	-	-	-	-	-	Tube
UTT30N10L-TQ2-R	UTT30N10G-TQ2-R	TO-263	G	D	S	-	-	-	-	-	Tape Reel
UTT30N10L-S08-R	UTT30N10G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel
UTT30N10L-K08-5060-R	UTT30N10G-K08-5060-R	DFN5060-8	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate    D: Drain    S: Source

	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF3: TO-220F, TM3: TO-251 TN3: TO-252, TQ2: TO-263, S08: SOP-8, K08-5060: DFN5060-8 (3) G: Halogen Free and Lead Free, L: Lead Free
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### ■ MARKING

PACKAGE	MARKING
TO-220 / TO-220F TO-251 / TO-252 TO-263	 <p>Lot Code ←      Date Code → 1</p> <p>L: Lead Free      G: Halogen Free</p>
SOP-8	 <p>8 7 6 5 UTC    1 2 3 4 UTT30N10 •      Date Code Lot Code →</p> <p>Date Code → L: Lead Free G: Halogen Free</p>
DFN5060-8	 <p>UTC UTT 30N10 •      Date Code Lot Code ←</p>

■ ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	100	V
Gate-Source Voltage		$V_{GSS}$	$\pm 20$	V
Drain Current	Continuous ( $V_{GS}=10\text{V}$ ) $T_C=25^\circ\text{C}$	$I_D$	30	A
	Pulsed	$I_{DM}$	60	A
Single Pulsed Avalanche Energy (Note 2)		$E_{AS}$	17	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.2	V/ns
Power Dissipation	TO-220/TO-263	$P_D$	95	W
	TO-220F		34	W
	TO-251/TO-252		44	W
	SOP-8		1.6	W
	DFN5060-8		13.6	W
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3.  $L=1\text{mH}$ ,  $I_{AS}=5.8\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD}\leq 11\text{A}$ ,  $di/dt\leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

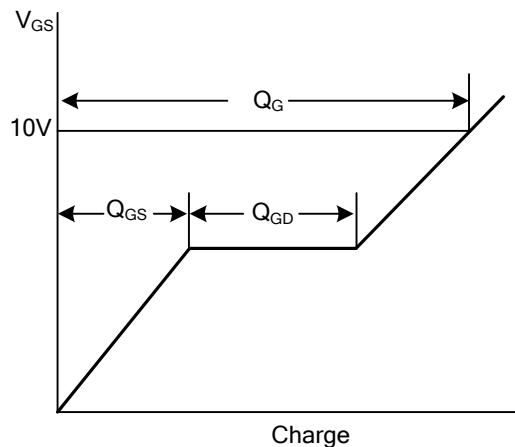
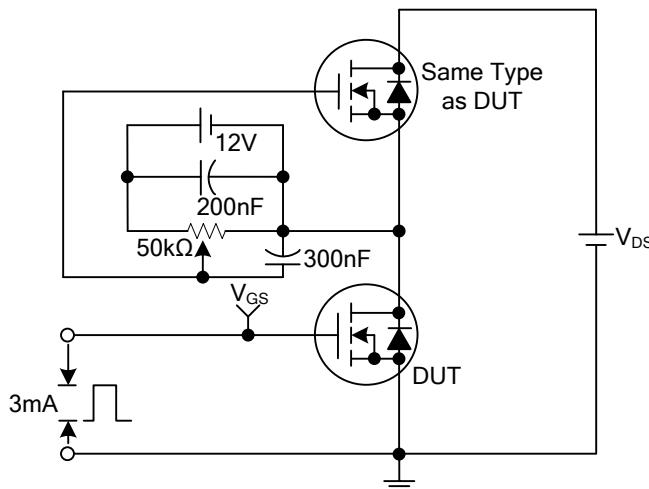
PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F	$\theta_{JA}$	62	$^\circ\text{C/W}$
	TO-263		110	$^\circ\text{C/W}$
	TO-251/TO-252		50	$^\circ\text{C/W}$
	SOP-8		65	$^\circ\text{C/W}$
	DFN5060-8		1.31	$^\circ\text{C/W}$
Junction to Case	TO-220/TO-263	$\theta_{JC}$	3.38	$^\circ\text{C/W}$
	TO-220F		2.85 (Note)	$^\circ\text{C/W}$
	TO-251/TO-252		78 (Note)	$^\circ\text{C/W}$
	SOP-8		9.1 (Note)	$^\circ\text{C/W}$
	DFN5060-8			

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

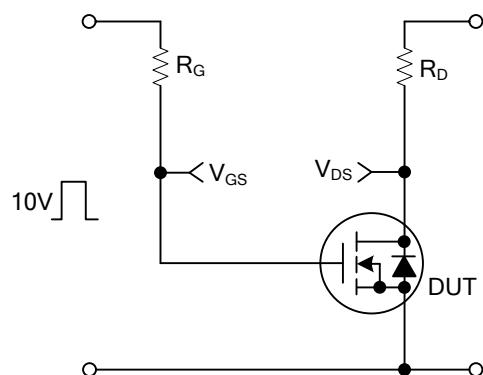
■ ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	100			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{DS}=100\text{V}, V_{GS}=0\text{V}$		1		$\mu\text{A}$
Gate- Source Leakage Current	<b>Forward</b> <b>Reverse</b>	$I_{\text{GSS}}$	$V_{GS}=+20\text{V}, V_{DS}=0\text{V}$		+100	nA
			$V_{GS}=-20\text{V}, V_{DS}=0\text{V}$		-100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0		3.0	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{GS}=10\text{V}, I_D=30\text{A}$		52		$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=15\text{A}$		72		$\text{m}\Omega$
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1.0\text{MHz}$		2200		pF
Output Capacitance	$C_{\text{OSS}}$			110		pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			75		pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge at 10V	$Q_G$	$V_{DS}=80\text{V}, V_{GS}=10\text{V}, I_D=30\text{A}, I_G=1\text{mA}$		43		nC
Gate to Source Charge	$Q_{GS}$			6.5		nC
Gate to Drain Charge	$Q_{GD}$			9		nC
Turn-ON Time	$t_{\text{ON}}$	$V_{DD}=50\text{V}, V_{GS}=10\text{V} I_D=10\text{A}, R_{GS}=3.3\Omega$		10		ns
Turn-ON Delay Time	$t_{D(\text{ON})}$			15		ns
Rise Time	$t_R$			35		ns
Turn-OFF Delay Time	$t_{D(\text{OFF})}$			16		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	$I_S$				30	A
Maximum Body-Diode Pulsed Current	$I_{SM}$				60	A
Drain-Source Diode Forward Voltage	$V_{SD}$	$I_{SD}=30\text{A}$			1.25	V
Body Diode Reverse Recovery Time	$t_{rr}$	$I_S=30\text{A}, V_{GS}=0\text{V}$		36		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$		$dI_F/dt=100\text{A}/\mu\text{s}$	50		$\mu\text{C}$

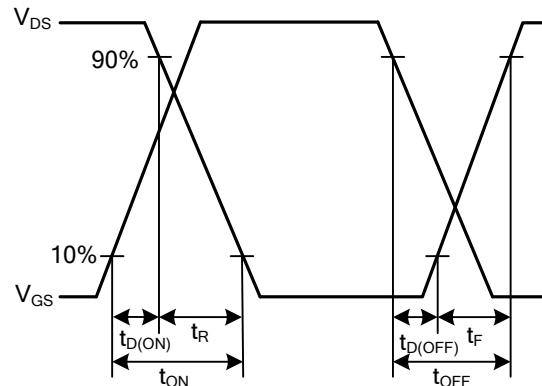
### ■ TEST CIRCUITS AND WAVEFORMS



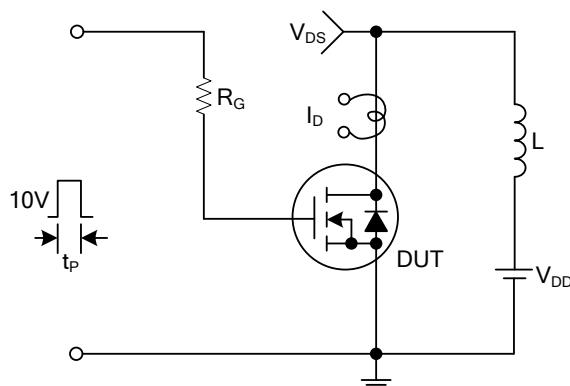
Gate Charge Test Circuit



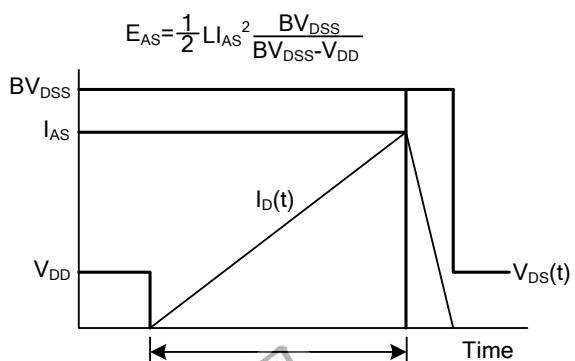
Gate Charge Waveforms



Resistive Switching Test Circuit



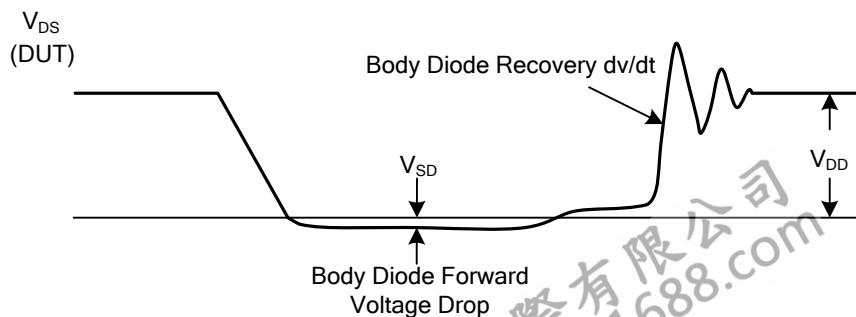
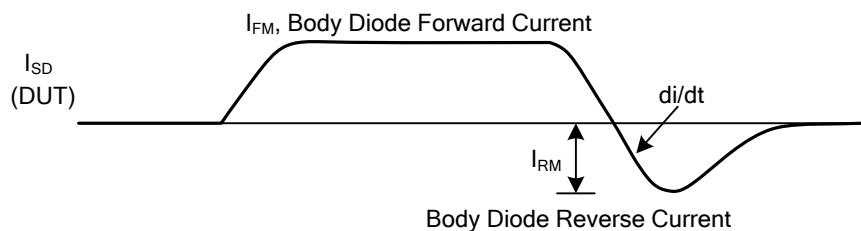
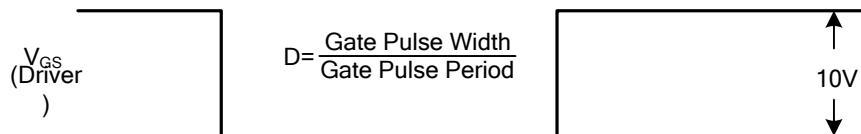
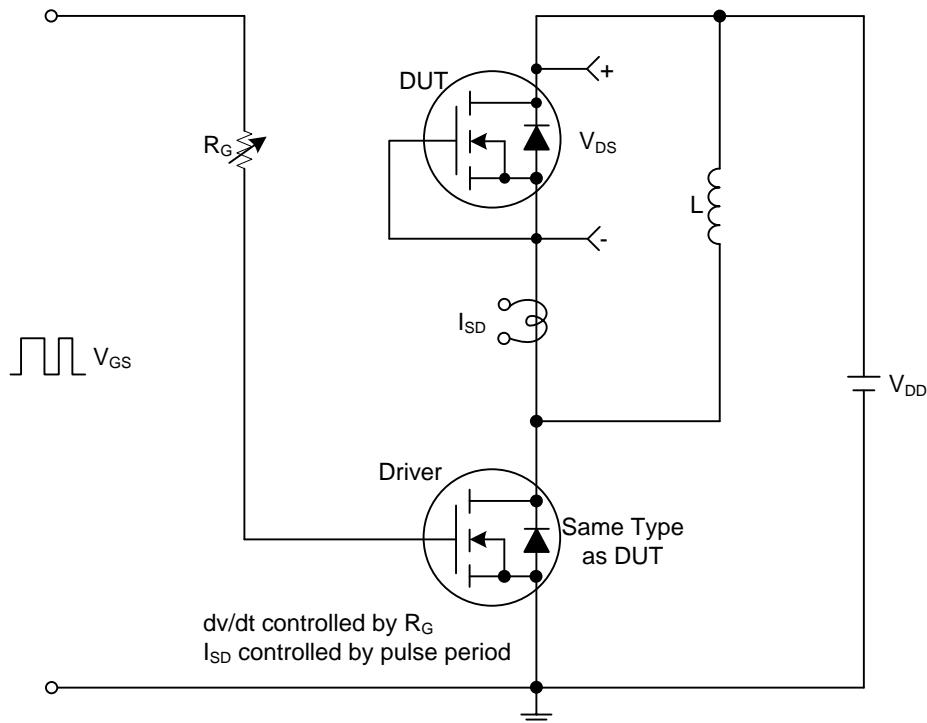
Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit

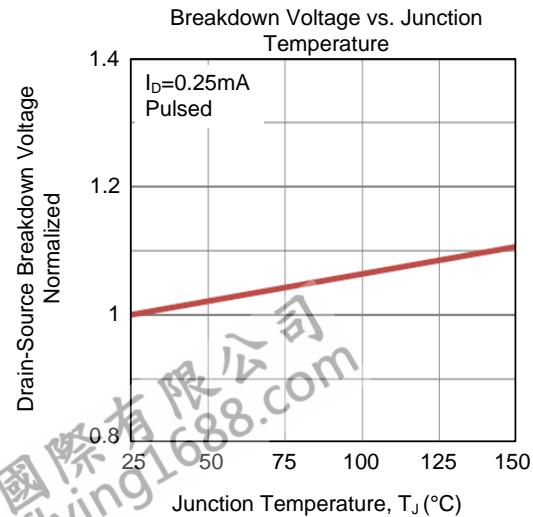
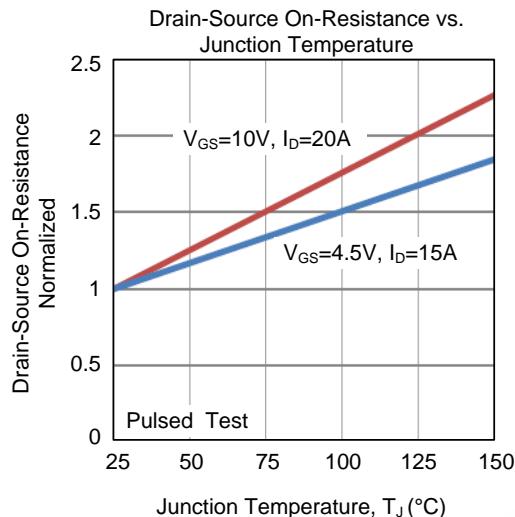
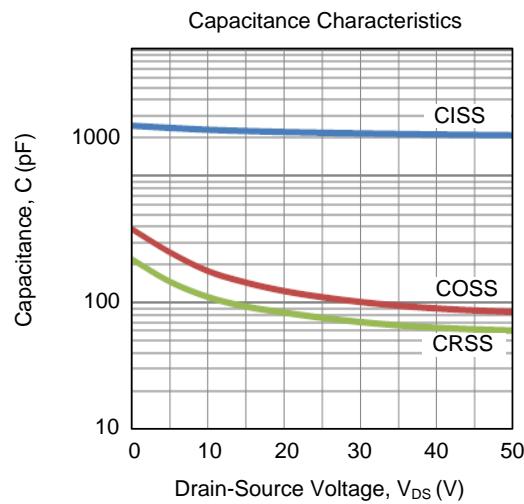
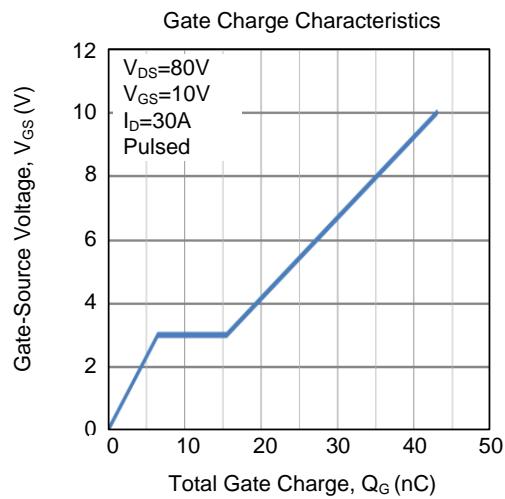
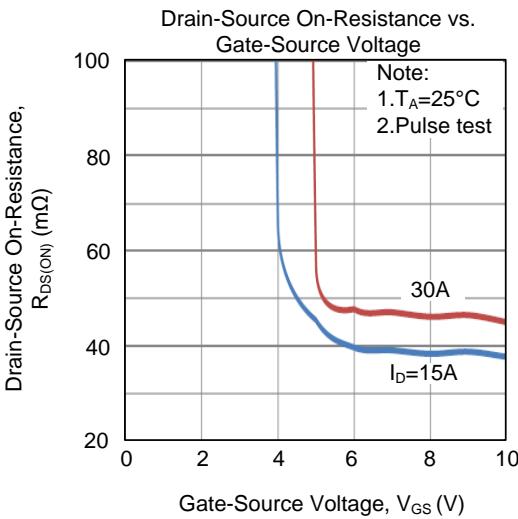
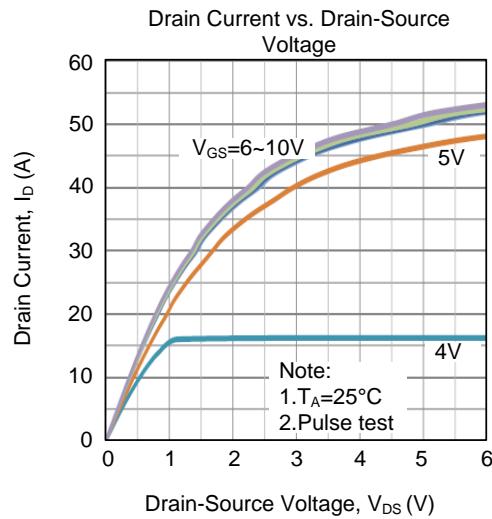
Unclamped Inductive Switching Waveforms

■ TEST CIRCUITS AND WAVEFORMS

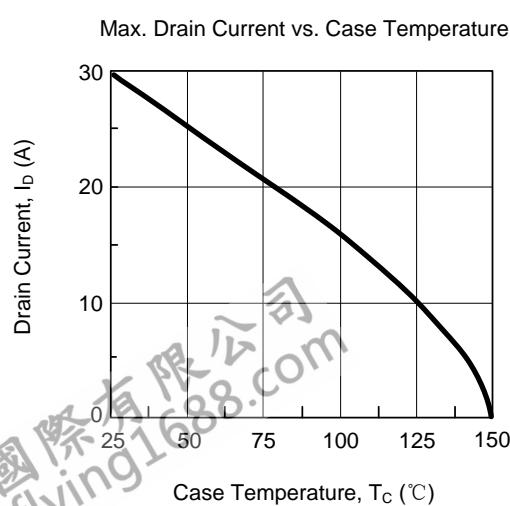
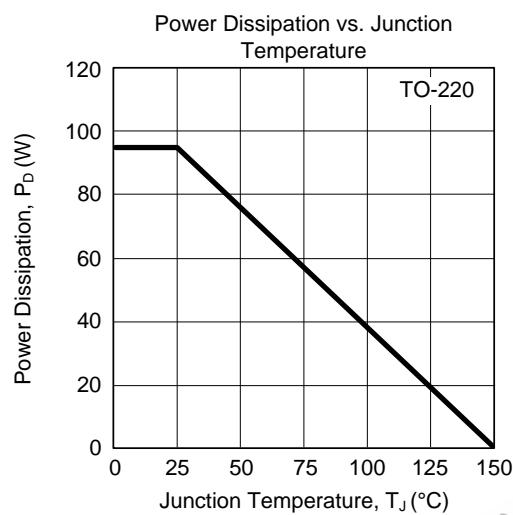
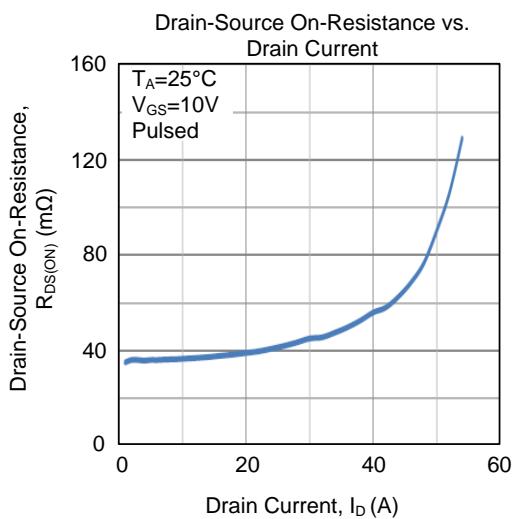
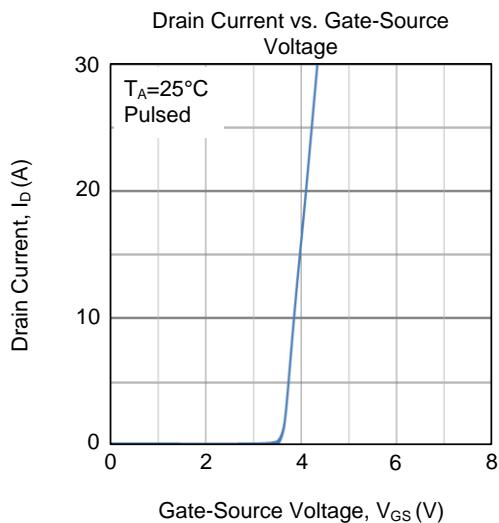
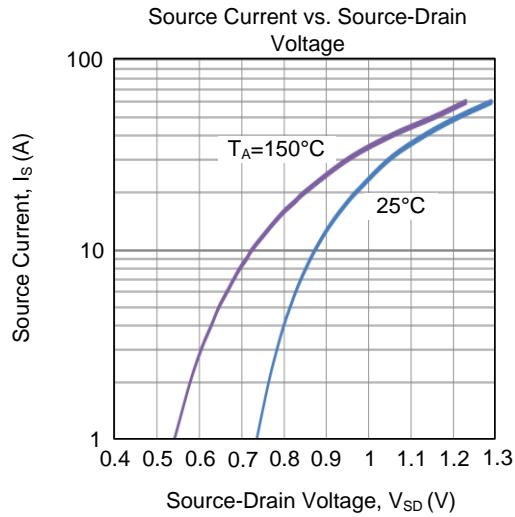
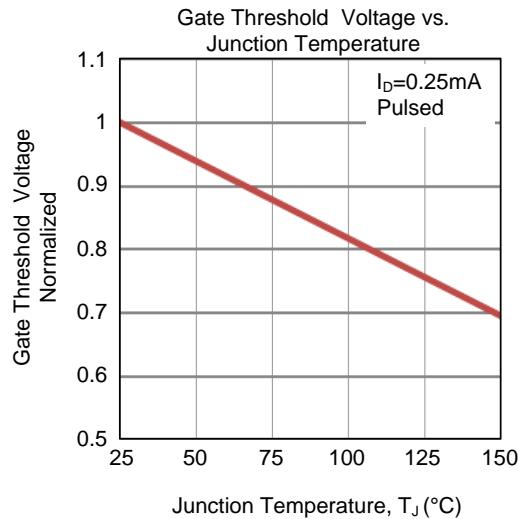


Peak Diode Recovery  $dv/dt$  Test Circuit and Waveforms

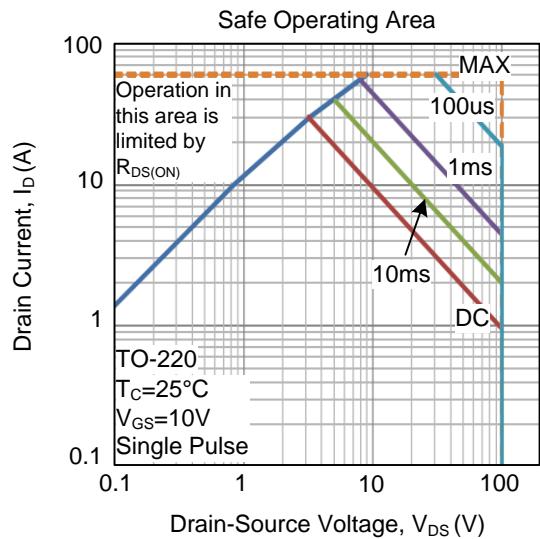
## ■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



### ■ TYPICAL CHARACTERISTICS (Cont.)



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